

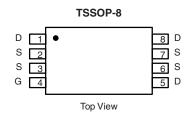
SI6433BDQ-T1-GE3-VB Datasheet P-Channel 20-V (G-S) MOSFET

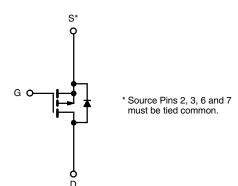
PRODUCT	UMMARY			
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)		
	0.010 at V _{GS} = - 4.5 V	- 9.0		
-20	0.012 at V _{GS} = - 2.5 V	- 7.8		
	0.016 at V _{GS} = - 1.8 V	- 6.0		

FEATURES

- Halogen-free
- Trench Power MOSFETs •







P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T_A	= 25 °C, unles	s otherwise n	oted			
Parameter		Symbol	10 s	Steady State	Unit	
Drain-Source Voltage		V _{DS}	-2	20	V	
Gate-Source Voltage		V _{GS}	±	12	V	
Continuous Drain Current /T 150 °C)	T _A = 25 °C	L_	- 9.0	-7.8		
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C	I _D	- 6.8	-5.8	•	
Pulsed Drain Current (10 µs Pulse Width)		I _{DM}	- :	30	A	
Continuous Source Current (Diode Conduction) ^a		۱ _S	- 1.35	- 0.95		
	T _A = 25 °C	PD	1.5 1.05		W	
Maximum Power Dissipation ^a	T _A = 70 °C		1.0	0.67	VV	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 t	o 150	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum lunction to Ambienta	$t \le 10 s$	R _{thJA}	65	83	
Maximum Junction-to-Ambient ^a	Steady State	' 'thJA	100	120	°C/W
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	43	52	

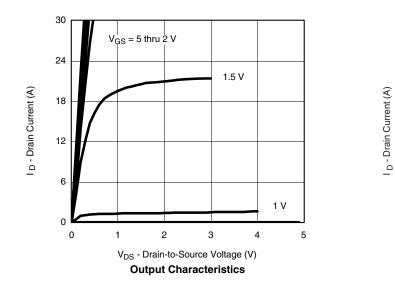
Notes: a. Surface Mounted on 1" x 1" FR4 board.

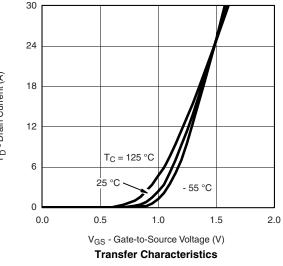
SPECIFICATIONS $T_J = 25 \text{ °C}$, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -450 \ \mu A$	- 0.45	-	1.0	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V$, $V_{GS} = \pm 8 V$			± 100	nA	
Zara Cata Valtaga Drain Current	Inne	$V_{DS} = -20 V, V_{GS} = 0 V$			- 1		
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = -20V, V_{GS} = 0 V, T_{J} = 70 \ ^{\circ}C$			- 25	μA	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = -5 V, V_{GS} = -4.5 V$	- 20			А	
Drain-Source On-State Resistance ^a		V _{GS} = - 4.5 V, I _D = - 8.0 A		0.010			
	R _{DS(on)}	V _{GS} = - 2.5 V, I _D = - 7.0 A		0.012		Ω	
		V _{GS} = - 1.8 V, I _D = - 5.8 A		0.016			
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 5 V, I _D = - 8.0 A		44		S	
Diode Forward Voltage ^a	V _{SD}	I _S = - 1.5 A, V _{GS} = 0 V		- 0.56	- 1.1	V	
Dynamic ^b							
Total Gate Charge	Qg			46	70		
Gate-Source Charge	Q _{gs}	V _{DS} = - 10 V, V _{GS} = - 4.5 V, I _D = - 8.0 A		5		nC	
Gate-Drain Charge	Q _{gd}			15.5			
Turn-On Delay Time	t _{d(on)}			45	70		
Rise Time	t _r	V _{DD} = - 10 V, <u></u> = 6 Ω		85	130		
Turn-Off Delay Time	t _{d(off)}	${\sf I}_{\sf D}\cong$ - 1 A, ${\sf V}_{\sf GEN}$ = - 4.5 V, ${\sf R}_{\sf g}$ = 6 Ω		220	400	ns	
Fall Time	t _f			155	235		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = - 1.5 A, di/dt = 100 A/μs		140	210		

Notes: a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

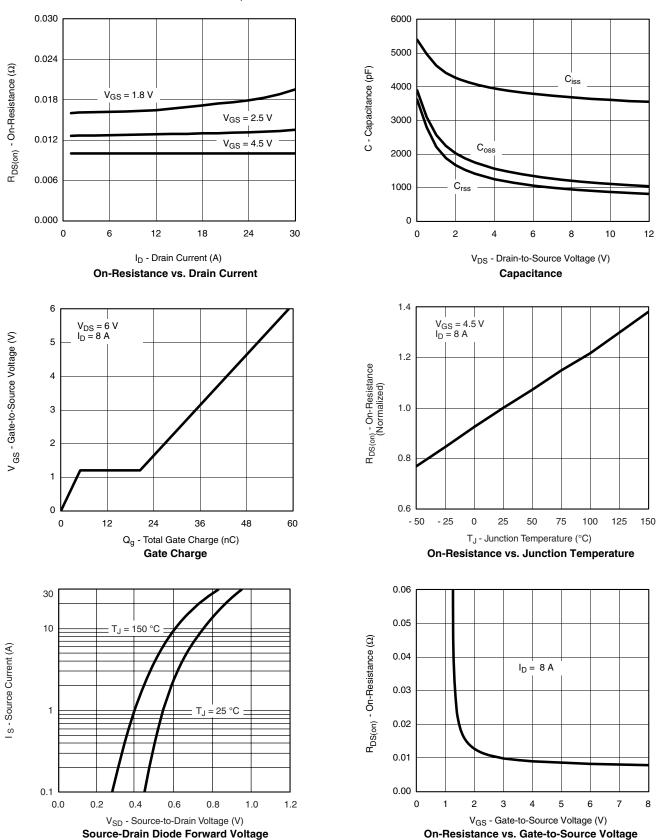




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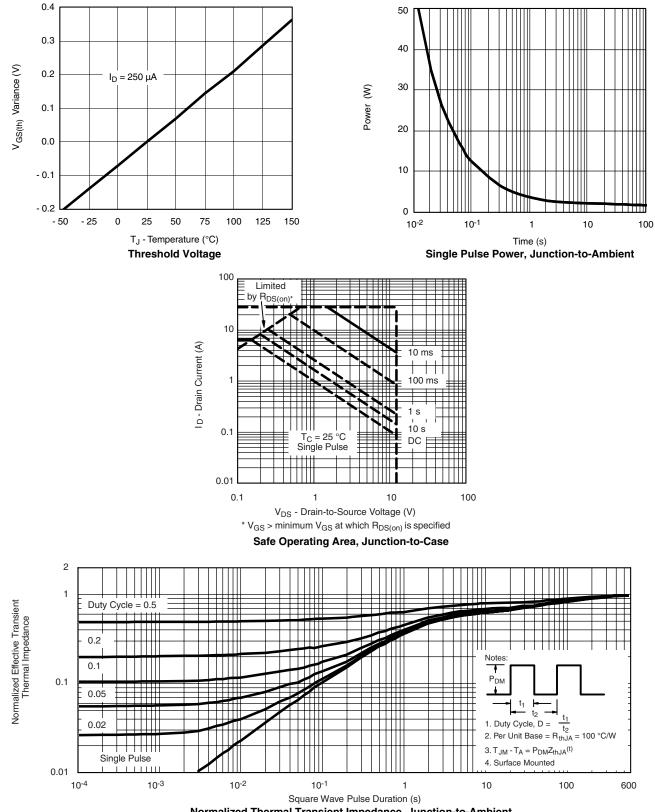








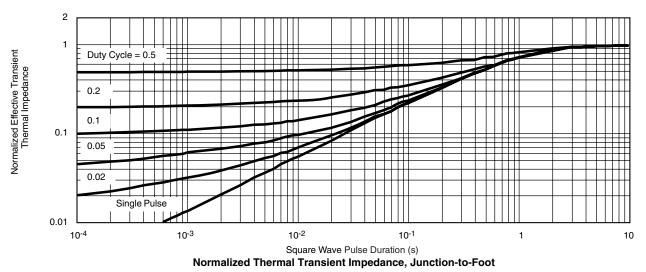
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

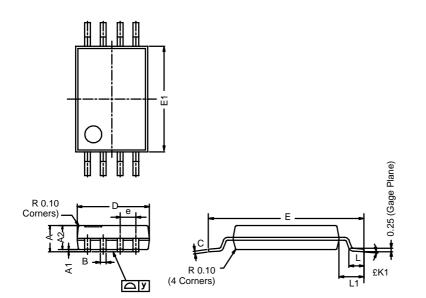


SI6433BDQ-T1-GE3-VB



TSSOP: 8-LEAD

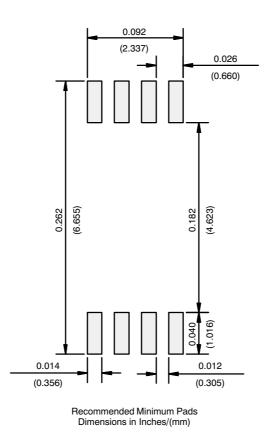
JEDEC Part Number: MO-153



Dim	MILLIMETERS			
	Min	Nom	Max	
Α	-	I	1.20	
A ₁	0.05	0.10	0.15	
A ₂	0.80	1.00	1.05	
В	0.19	0.28	0.30	
С	-	0.127	-	
D	2.90	3.00	3.10	
Е	6.20	6.40	6.60	
E ₁	4.30	4.40	4.50	
е	-	0.65	-	
L	0.45	0.60	0.75	
L ₁	0.90	1.00	1.10	
Y	-	-	0.10	
£ K1	0°	3°	6°	



RECOMMENDED MINIMUM PADS FOR TSSOP-8



服务热线:400-655-8788



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